**Preferred Devices** 

# **Surface Mount Schottky Power Rectifier**

... employing the Schottky Barrier principle in a large area metal-to-silicon power diode. State-of-the-art geometry features epitaxial construction with oxide passivation and metal overlay contact. Ideally suited for low voltage, high frequency rectification, or as free wheeling and polarity protection diodes, in surface mount applications where compact size and weight are critical to the system.

- Small Compact Surface Mountable Package with J-Bend Leads
- Rectangular Package for Automated Handling
- Highly Stable Oxide Passivated Junction
- Very Low Forward Voltage Drop (0.5 Volts Max @ 3.0 A, T<sub>J</sub> = 25°C)
- Excellent Ability to Withstand Reverse Avalanche Energy Transients
- Guardring for Stress Protection
- Pb-Free Packages are Available

### **Mechanical Characteristics:**

- Case: Epoxy, Molded, Epoxy Meets UL 94, V-0
- Weight: 217 mg (approximately)
- Finish: All External Surfaces Corrosion Resistant and Terminal Leads are Readily Solderable
- Lead and Mounting Surface Temperature for Soldering Purposes: 260°C Max. for 10 Seconds
- Shipped in 16 mm Tape and Reel, 2500 units per reel
- Polarity: Notch in Plastic Body Indicates Cathode Lead
- Device Meets MSL 1 Requirements
- ESD Ratings: Machine Model, C (> 400 V) Human Body Model, 3B (> 8000 V)
- Marking: B32, B33, B34

### **MAXIMUM RATINGS**

Please See the Table on the Following Page



ON Semiconductor®

http://onsemi.com

SCHOTTKY BARRIER RECTIFIERS 3.0 AMPERES 20, 30, 40 VOLTS



MARKING DIAGRAM

YWW

B3x



SMC CASE 403 PLASTIC

> B3x = Device Code x = 2, 3 or 4 Y = Year WW = Work Week

### **ORDERING INFORMATION**

= Pb-Free Package

Device	Package	Shipping <sup>†</sup>	
MBRS320T3	SMC	2500/Tape & Reel	
MBRS320T3G	SMC (Pb-Free)	2500/Tape & Reel	
MBRS330T3	SMC	2500/Tape & Reel	
MBRS330T3G	SMC (Pb-Free)	2500/Tape & Reel	
MBRS340T3	SMC	2500/Tape & Reel	
MBRS340T3G	SMC (Pb-Free)	2500/Tape & Reel	

†For information on tape and reel specifications, including part orientation and tape sizes, please refer to our Tape and Reel Packaging Specification Brochure, BRD8011/D.

**Preferred** devices are recommended choices for future use and best overall value.

### **MAXIMUM RATINGS**

Rating	Symbol	MBRS320T3	MBRS330T3	MBRS340T3	Unit
Peak Repetitive Reverse Voltage Working Peak Reverse Voltage DC Blocking Voltage	V <sub>RRM</sub> V <sub>RWM</sub> V <sub>R</sub>	20	30	40	Volts
Average Rectified Forward Current	I <sub>F(AV)</sub>	3.0 @ T <sub>L</sub> = 110°C 4.0 @ T <sub>L</sub> = 105°C		Amps	
Nonrepetitive Peak Surge Current (Surge applied at rated load conditions halfwave, single phase, 60 Hz)	I <sub>FSM</sub>	80			Amps
Operating Junction Temperature	TJ	- 65 to +125			°C
THERMAL CHARACTERISTICS					
Thermal Resistance — Junction to Lead	$R_{ heta JL}$	11			°C/W
ELECTRICAL CHARACTERISTICS					•
Maximum Instantaneous Forward Voltage (Note 1) (i <sub>F</sub> = 3.0 A, T <sub>J</sub> = 25°C)	V <sub>F</sub>	0.50			Volts
Maximum Instantaneous Reverse Current (Note 1) (Rated dc Voltage, T <sub>J</sub> = 25°C) (Rated dc Voltage, T <sub>i</sub> = 100°C)	i <sub>R</sub>	2.0 20			mA

<sup>1.</sup> Pulse Test: Pulse Width = 300 μs, Duty Cycle ≤ 2.0%.

### TYPICAL ELECTRICAL CHARACTERISTICS

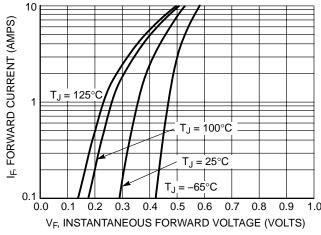


Figure 1. Typical Forward Voltage

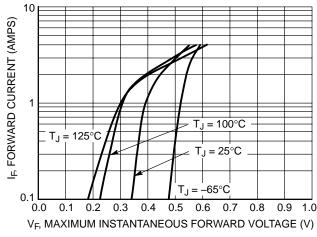
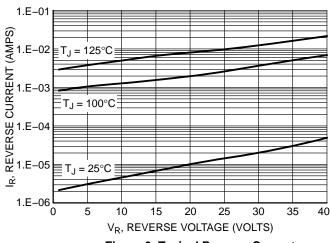
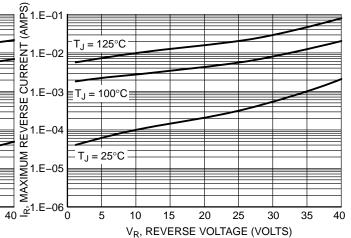


Figure 2. Maximum Forward Voltage



**Figure 3. Typical Reverse Current** 



**Figure 4. Maximum Reverse Current** 

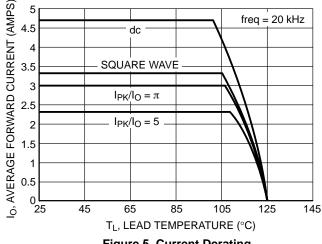


Figure 5. Current Derating

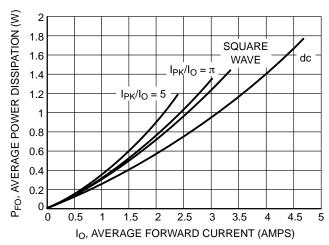


Figure 6. Forward Power Dissipation

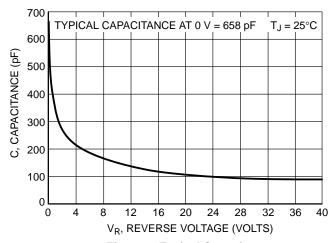
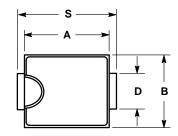


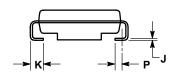
Figure 7. Typical Capacitance

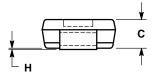
### **PACKAGE DIMENSIONS**

### **SMC**

PLASTIC PACKAGE CASE 403-03 ISSUE D



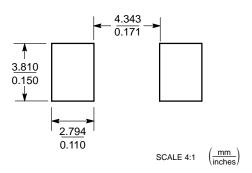




- NOTES:
  1. DIMENSIONING AND TOLERANCING PER ANSI Y14.5M, 1982.
  2. CONTROLLING DIMENSION: INCH.
  3. D DIMENSION SHALL BE MEASURED WITHIN DIMENSION P.
  4. 403-01 THRU -02 OBSOLETE, NEW STANDARD 403-03.

	INCHES		MILLIMETERS	
DIM	MIN	MAX	MIN	MAX
Α	0.260	0.280	6.60	7.11
В	0.220	0.240	5.59	6.10
С	0.075	0.095	1.90	2.41
D	0.115	0.121	2.92	3.07
Н	0.0020	0.0060	0.051	0.152
J	0.006	0.012	0.15	0.30
K	0.030	0.050	0.76	1.27
P	0.020 REF		0.51	REF
S	0.305	0.320	7.75	8.13

### **SOLDERING FOOTPRINT\***



<sup>\*</sup>For additional information on our Pb–Free strategy and soldering details, please download the ON Semiconductor Soldering and Mounting Techniques Reference Manual, SOLDERRM/D.

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